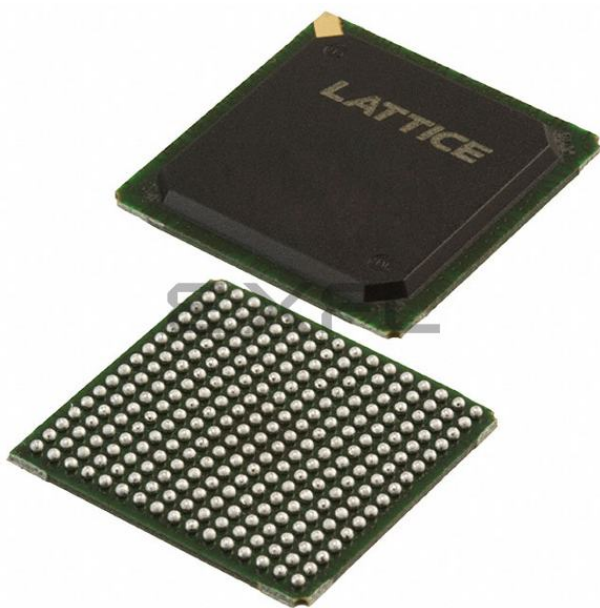




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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	8
Number of Macrocells	256
Number of Gates	-
Number of I/O	141
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5256mv-5f256i



Product Line	Ordering Part Number	Product Status	Reference PCN
LC5512MV	LC5512MV-45Q208C	Active / Orderable	
	LC5512MV-45QN208C		
	LC5512MV-75Q208C		
	LC5512MV-75QN208C		
	LC5512MV-75Q208I		
	LC5512MV-75QN208I		
	LC5512MV-45F256C		
	LC5512MV-45FN256C		
	LC5512MV-75F256C		
	LC5512MV-75FN256C		
	LC5512MV-75F256I		
	LC5512MV-75FN256I		
	LC5512MV-45F484C		
	LC5512MV-45FN484C		
	LC5512MV-75F484C		
	LC5512MV-75FN484C		
	LC5512MV-75F484I		
	LC5512MV-75FN484I		
LC5512MB	LC5512MB-45Q208C	Discontinued	PCN#09-10
	LC5512MB-45QN208C		
	LC5512MB-75Q208C		
	LC5512MB-75QN208C		
	LC5512MB-75Q208I		
	LC5512MB-75QN208I		
	LC5512MB-45F256C	Active / Orderable	
	LC5512MB-45FN256C		
	LC5512MB-75F256C		
	LC5512MB-75FN256C		
	LC5512MB-75F256I		
	LC5512MB-75FN256I		
	LC5512MB-45F484C	Discontinued	PCN#09-10
	LC5512MB-45FN484C		
	LC5512MB-75F484C		
	LC5512MB-75FN484C		
	LC5512MB-75F484I		
	LC5512MB-75FN484I		
LC5512MC	LC5512MC-45Q208C	Discontinued	PCN#09-10
	LC5512MC-45QN208C		
	LC5512MC-75Q208C		
	LC5512MC-75QN208C		
	LC5512MC-75Q208I		
	LC5512MC-75QN208I		
	LC5512MC-45F256C		
	LC5512MC-45FN256C		
	LC5512MC-75F256C		
	LC5512MC-75FN256C		
	LC5512MC-75F256I		
	LC5512MC-75FN256I		

Figure 1. ispXPLD 5000MX Block Diagram



Introduction

The ispXPLD 5000MX family represents a new class of device, referred to as the eXpanded Programmable Logic Devices (XPLDs). These devices extend the capability of Lattice's popular SuperWIDE ispMACH 5000 architecture by providing flexible memory capability. The family supports single- or dual-port SRAM, FIFO, and ternary CAM operation. Extra logic has also been included to allow efficient implementation of arithmetic functions. In addition, sysCLOCK PLLs and sysIO interfaces provide support for the system-level needs of designers.

The devices provide designers with a convenient one-chip solution that provides logic availability at boot-up, design security, and extreme reconfigurability. The use of advanced process technology provides industry-leading performance with combinatorial propagation delay as low as 4.0ns, 2.8ns clock-to-out delay, 2.2ns set-up time, and operating frequency up to 300MHz. This performance is coupled with low static and dynamic power consumption. The ispXPLD 5000MX architecture provides predictable deterministic timing.

The availability of 3.3, 2.5 and 1.8V versions of these devices along with the flexibility of the sysIO interface helps users meet the challenge of today's mixed voltage designs. Inputs can be safely driven up to 5.5V when an I/O bank is configured for 3.3V operation, making this family 5V tolerant. Boundary scan testability further eases integration into today's complex systems. A variety of density and package options increase the likelihood of a good fit for a particular application. Table 1 shows the members of the ispXPLD 5000MX family.

Architecture

The ispXPLD 5000MX devices consist of Multi-Function Blocks (MFBs) interconnected with a Global Routing Pool. Signals enter and leave the device via one of four sysIO banks. Figure 1 shows the block diagram of the ispXPLD

Figure 3. MFB in SuperWIDE Logic Mode†

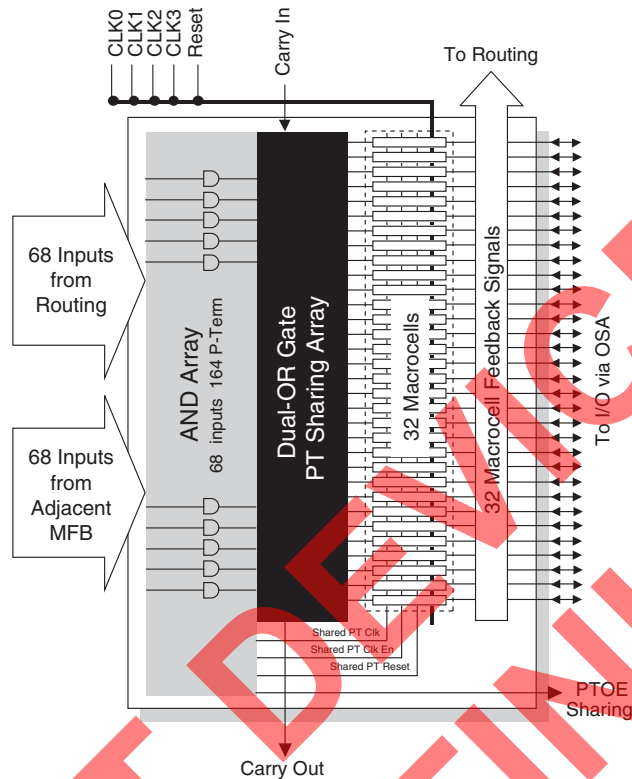


Figure 4. Macrocell Slice in Logic Mode AND-Array

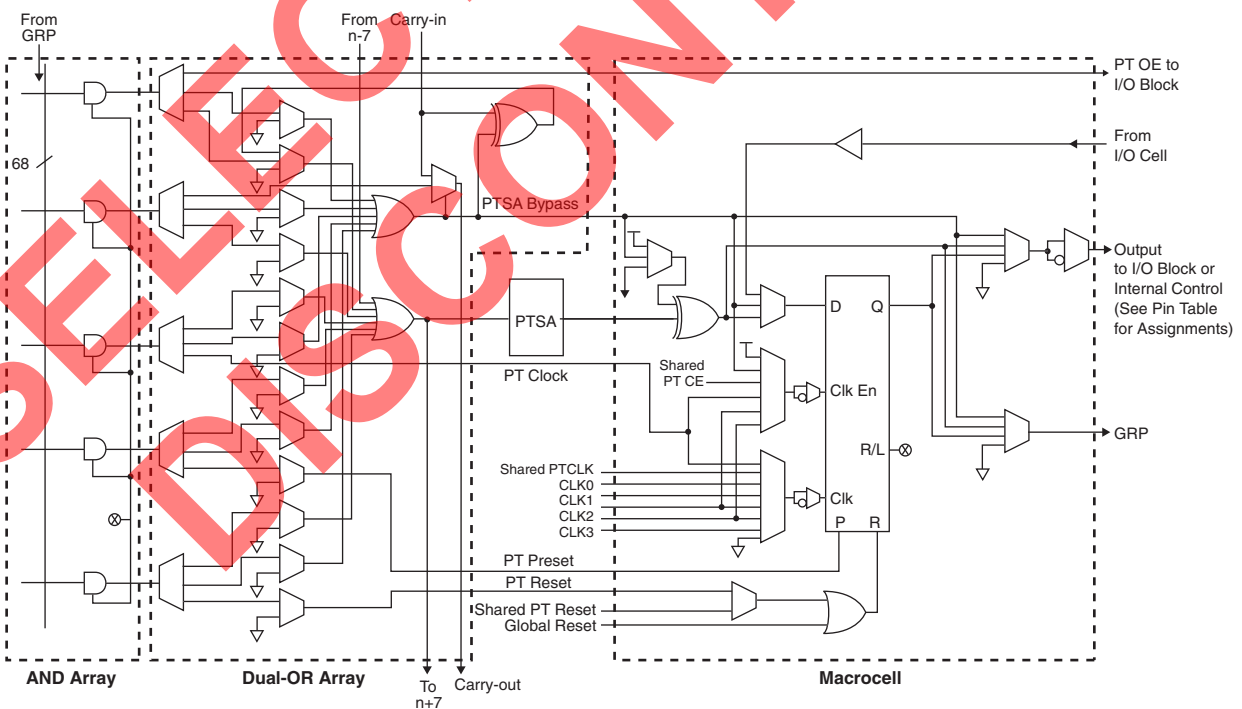


Table 12. ispXPLD 5000MX Supported I/O Standards

sysIO Standard	Nominal V_{CCO}	Nominal V_{REF}	Nominal V_{TT}
LVTTL	3.3V	N/A	N/A
LVC MOS-3.3	3.3V	N/A	N/A
LVC MOS-2.5	2.5V	N/A	N/A
LVC MOS-1.8	1.8V	N/A	N/A
PCI 3.3V	3.3V	N/A	N/A
AGP-1X	3.3V	N/A	N/A
SSTL3, Class I & II	3.3V	1.5V	1.5V
SSTL2, Class I & II	2.5V	1.25V	1.25V
CTT 3.3	3.3V	1.5V	1.5V
CTT 2.5	2.5V	1.25V	1.25V
HSTL, Class I	1.5V	0.75V	0.75V
HSTL, Class III	1.5V	0.9V	0.75V
HSTL, Class IV	1.5V	0.9V	0.75V
GTL+	N/A	1.0V	1.5V
LVPECL, Differential	2.5V, 3.3V	N/A	N/A
LVDS	2.5V, 3.3V	N/A	N/A

Table 13. Differential Interface Standard Support¹

		sysIO Buffer
LVDS	Driver	Supported
	Receiver	Supported with standard termination
LVPECL	Driver	Supported with external resistor network
	Receiver	Supported with termination

1. For more information, refer to TN1000 – [sysIO Usage Guidelines for Lattice Devices](#).

Control, Clock, sysCONFIG and JTAG Signals

Global clock pins support the same sysIO standards as general purpose I/O. When required the V_{REF} signal is derived from the adjacent bank. When differential standards are supported two adjacent clock pins are paired to form the input. The TOE, PROGRAM, CFG0 and DONE pins of the ispXPLD 5000MX device are the only pins that do not have sysIO capabilities. The JTAG TAP pins support only LVC MOS 3.3, 2.5 and 1.8V standards. The voltage is controlled by V_{CCJ} . These pins only support the LVTTL and LVC MOS standards applicable to the power supply voltage of the device. The global reset global output enable pins are associated with Bank 2 and support all of the sysIO standards.

Hotsocketing

The I/O on the ispXPLD 5000MX devices are well suited for those applications that require hot socketing capability, when configured as LVC MOS or LVTTL. Hot socketing a device requires that the device, when powered down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of the powered-down device be minimal on active signals.

Programmable Drive Strength

The drive strength of I/Os that are programmed as LVC MOS is tightly controlled and can be programmed to a variety of different values. Thus the impedance an output driver can be closely match to the characteristic impedance of the line it is driving. This allows users to eliminate the need for external series termination resistors.

Programmable Slew Rate

The slew rate of outputs is carefully controlled. When outputs are configured as LVCMOS the devices support two slew rates. This allows system noise and performance to be balanced in a design.

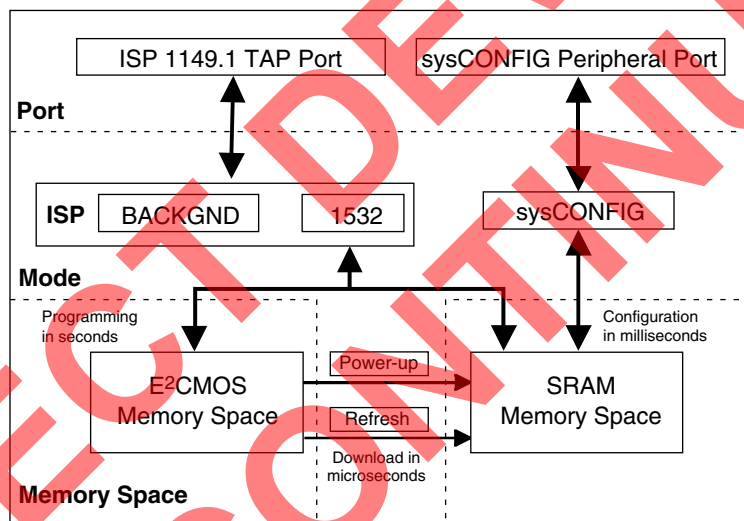
Programmable Bus-Maintenance

All general-purpose inputs have programmable bus maintenance circuitry. These are intended to maintain a valid logic level into a device when driving devices go into the tri-state mode. Four options are available for users: pull-up, pull-down, bus-keeper, or nothing.

Expanded In-System Programmability (ispXP)

The ispXPLD 5000MX family utilizes a combination of EEPROM non-volatile cells and SRAM technology to deliver a logic solution that provides “instant-on” at power-up, a convenient single chip solution, and the capability for infinite reconfiguration. A non-volatile array distributed within the device stores the device configuration. At power-up this information is transferred in a massively parallel fashion into SRAM bits that control the operation of the device. Figure 18 shows the different ports and modes that are used in the configuration and programming of the ispXPLD 5000MX devices.

Figure 18. ispXP Block Diagram



IEEE 1532 ISP

In-system programming of devices provides a number of significant benefits including rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispXPLD 5000MX devices provide in-system programmability through their Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains compliant to the IEEE 1532 standard. By using IEEE 1532 as the communication interface through which ISP is achieved, customers get the benefit of a standard, well-defined interface.

The IEEE1532 programming interface allows programming of either the non-volatile array or reconfiguration of the SRAM bits.

The ispXPLD 5000MX devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispXPLD 5000MX devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispXPLD 5000MX devices during the testing of a circuit board.

Supply Current

Symbol	Parameter	Condition	Min.	Typ. ³	Max.	Units
ispXPLD 5256						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	26	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	26	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	16	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA
ispXPLD 5512						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	33	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	33	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	22	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA
ispXPLD 5768						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	40	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	40	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	30	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA

Supply Current (Continued)

Symbol	Parameter	Condition	Min.	Typ. ³	Max.	Units
ispXPLD 51024						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	75	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	75	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	55	—	mA
I_{CCO}	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{ unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{ unloaded}$	—	3	—	mA
I_{CCP}	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
I_{CCJ}	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA

1. Device configured with 16-bit counters.

2. I_{CC} varies with specific device configuration and operating frequency.3. $T_A = 25^\circ C$

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
Registered Delays													
t _S	D-Register Setup Time, Global Clock	—	0.28	—	0.31	—	0.35	—	0.55	—	0.52	—	ns
t _{S_PT}	D-Register Setup Time, PT Clock	—	-0.13	—	-0.11	—	-0.10	—	-0.10	—	-0.07	—	ns
t _H	D-Register Hold Time	—	1.90	—	2.56	—	2.50	—	2.40	—	4.00	—	ns
t _{COi}	Register Clock to OSA Time	—	—	0.72	—	1.03	—	0.68	—	0.93	—	1.50	ns
t _{CESi}	Clock Enable Setup Time	—	1.07	—	1.20	—	1.33	—	1.33	—	2.00	—	ns
t _{CEHi}	Clock Enable Hold Time	—	0.00	—	0.00	—	0.00	—	0.00	—	0.00	—	ns
t _{SIR}	D-Input Register Setup Time, Global Clock	—	0.66	—	0.20	—	0.53	—	0.12	—	0.08	—	ns
t _{SIR_PT}	D-Input Register Setup Time, PT Clock	—	0.42	—	0.37	—	0.34	—	0.34	—	0.22	—	ns
t _{HIR}	D-Input Register Hold Time, Global Clock	—	0.84	—	1.31	—	1.01	—	1.41	—	2.91	—	ns
t _{HIR_PT}	D-Input Register Hold Time, PT Clock	—	0.00	—	0.00	—	0.00	—	0.00	—	0.00	—	ns
Latched Delays													
t _{SL}	Latch Setup Time, Global Clock	—	0.18	—	0.00	—	0.00	—	0.00	—	0.00	—	ns
t _{SL_PT}	Latch Setup Time, PT Clock	—	0.18	—	0.00	—	0.00	—	0.00	—	0.34	—	ns
t _{HL}	Latch Hold Time	—	-0.06	—	0.00	—	0.00	—	0.00	—	-0.03	—	ns
t _{GOi}	Latch Gate to OSA Time	—	—	0.07	—	0.08	—	0.08	—	0.08	—	0.13	ns
t _{PDLi}	Propagation Delay through Latch to OSA Transparent	—	—	0.52	—	0.58	—	0.65	—	0.65	—	0.97	ns
Reset and Set Delays													
t _{SRI}	Asynchronous Reset or Set to OSA Delay	—	—	0.23	—	0.26	—	0.29	—	0.29	—	0.43	ns
t _{SRR}	Asynchronous Reset or Set Recovery	—	—	0.42	—	0.47	—	0.53	—	0.55	—	0.79	ns
eXtended Function Routing Delays													
t _{ROUTE MF}	Delay through SRP when Implementing Memory Functions	—	—	2.00	—	2.25	—	2.51	—	2.61	—	3.76	ns

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{FIFOWES}	Write-Enable setup before Write Clock	—	2.33	—	2.33	—	2.91	—	2.91	—	3.03	—	ns
t _{FIFOWEH}	Write-Enable hold after Write Clock	—	-2.95	—	-2.95	—	-2.36	—	-2.36	—	-2.27	—	ns
t _{FIFORES}	Read-Enable setup before Read Clock	—	2.69	—	2.35	—	2.79	—	2.38	—	4.14	—	ns
t _{FIFOREH}	Read-Enable hold after Read Clock	—	-3.17	—	-3.17	—	-2.53	—	-2.53	—	-2.44	—	ns
t _{FIFORSTO}	Reset to Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
t _{FIFORSTR}	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
t _{FIFORSTPW}	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
t _{FIFORCLKO}	Read Clock to FIFO Out Delay	—	—	3.73	—	3.73	—	4.66	—	4.66	—	4.84	ns
CAM – Update Mode													
t _{CAMMSS}	Memory Select Setup before CLK	—	1.40	—	0.70	—	1.50	—	1.40	—	1.44	—	ns
t _{CAMMSH}	Memory Select Hold after CLK	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMENMSKS}	Enable Mask Register Setup Time before CLK	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMENMSKH}	Enable Mask Register Setup Time after CLK	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMADDS}	Address Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMADDH}	Address Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMDATAS}	Data Setup Time before Clock	—	-0.41	—	-0.41	—	-0.33	—	-0.33	—	-0.31	—	ns
t _{CAMDATAH}	Data Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMDACS}	“Don’t Care” Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMDCH}	“Don’t Care” Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMRWS}	R/W Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMRWH}	R/W Enable Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMCES}	Clock Enable Setup Time before Clock	—	1.55	—	1.55	—	1.94	—	1.94	—	2.02	—	ns
t _{CAMCEH}	Clock Enable Hold Time after Clock	—	-2.95	—	-2.95	—	-2.36	—	-2.36	—	-2.27	—	ns

ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{CAMWMSKS}	Write Mask Register Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMWMSKH}	Write Mask Register Setup Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMRSTO}	Reset to CAM Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
t _{CAMRSTR}	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
t _{CAMRSTPW}	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
CAM – Compare Mode													
t _{CAMDATAS}	Data Setup Time before Clock	—	-0.41	—	-0.41	—	-0.33	—	-0.33	—	-0.31	—	ns
t _{CAMDATAH}	Data Hold Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMENMSKS}	Enable Mask Register Setup Time before Clock	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
t _{CAMENMSKH}	Enable Mask Register Setup Time after Clock	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{CAMCASC}	CAM Width Expansion Delay	—	—	0.40	—	0.40	—	0.50	—	0.50	—	0.51	ns
t _{CAMCO}	Clock to Output (Address Out) Delay	—	—	6.19	—	6.13	—	6.81	—	6.61	—	9.63	ns
t _{CAMMATCH}	Clock to Match Flag Delay	—	—	6.19	—	6.13	—	6.07	—	6.61	—	10.22	ns
t _{CAMMMATCH}	Clock to Multi-Match Flag Delay	—	—	5.50	—	5.50	—	6.38	—	6.38	—	7.72	ns
t _{CAMRSTFLAG}	CAM Reset to Flags Delay	—	—	3.16	—	3.16	—	3.95	—	3.95	—	4.11	ns
Single Port RAM													
t _{SPADDDATA}	Address to Data Delay	—	—	5.97	—	5.97	—	5.97	—	5.97	—	7.76	ns
t _{SPMSS}	Memory Select Setup Before Clock Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
t _{SPMSH}	Memory Select Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
t _{SPCES}	Clock Enable Setup before Clock Time	—	2.30	—	2.30	—	2.30	—	2.30	—	9.80	—	ns
t _{SPCEH}	Clock Enable Hold time after Clock Time	—	-2.95	—	-2.95	—	-2.95	—	-2.95	—	-2.27	—	ns
t _{SPADDS}	Address Setup before Clock Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns

ispXPLD 5000MX Family Timing Adders

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{IOI} Input Adjusters													
LVTTTL_in	Using 3.3V TTL	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_18_in	Using 1.8V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_25_in	Using 2.5V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVC MOS_33_in	Using 3.3V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_in	Using AGP 1x	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_in	Using HSTL 2.5V, Class IV	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
LVPECL_in	Using Low Voltage PECL	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
PCI_in	Using PCI	t _{IOIN}	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t _{IOIN}	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t _{IOIN}	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
t _{IOO} Output Adjusters – Output Signal Modifiers													
Slow Slew	Using Slow Slew (LVTTTL and LVC MOS Outputs Only)	t _{IOBUF} , t _{IOEN}	—	0.9	—	0.9	—	0.9	—	0.9	—	0.9	ns
t _{IOO} Output Adjusters – Output Configurations													
LVTTTL_out	Using 3.3V TTL Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVC MOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
LVC MOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns

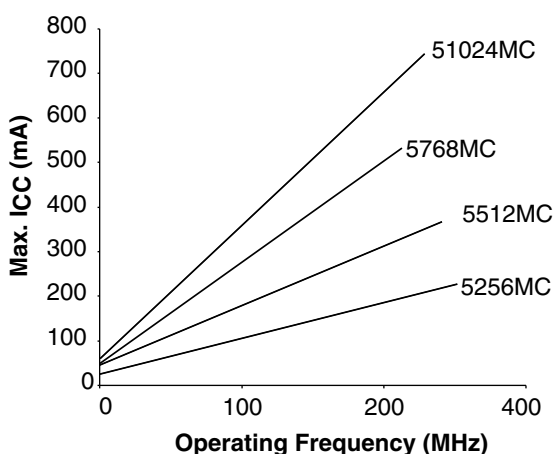
Boundary Scan Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min	Max	Units
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	10	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUPOEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

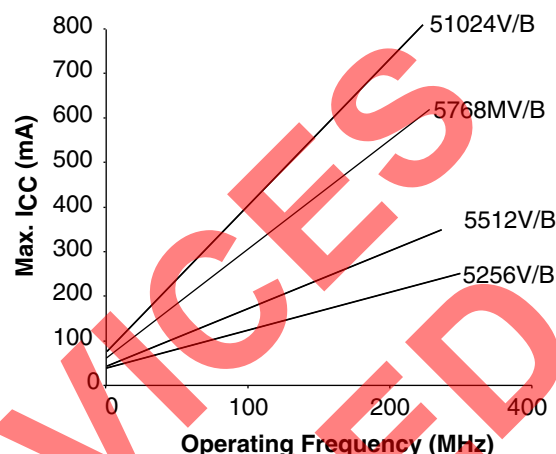
Power Consumption

ispXPLD 5000MC Typical I_{CC} vs. Frequency



Note: The device is configured with maximum number of 16-bit counters, no PLL, typical current at 1.8V, 25°C.

ispXPLD 5000MV/B Typical I_{CC} vs. Frequency



Note: The device is configured with maximum number of 16-bit counters, no PLL, typical current at 3.3V (MV) or 2.5V (MB), 25°C.

Power Estimation Coefficients

Device	K0	K1	K2	K3	K4	K5	K6	K7	DC	
									ispXPLD 5000MC	ispXPLD 5000MV/B
ispXPLD 5256	2.2	8.4	7	12	100	0.1379	0.0433	6.476	16	24
ispXPLD 5512	2.2	8.4	9.4	18	151	0.1379	0.0433	6.476	17	25
ispXPLD 5768	2.2	8.4	10.2	21	170	0.1379	0.0433	6.476	27	36
ispXPLD 51024	2.2	8.4	13	27.6	200	0.1379	0.0433	6.476	35	43

Note: For further information about the use of these coefficients, refer to TN1031 – [Power Estimation in ispXPLD 5000MX Devices](#).

Memory Coefficients

Device	K8	K9	K10	K11
ispXPLD 5256	0.004719	0.0924	4.4	2.9
ispXPLD 5512	0.004719	0.0924	4.4	2.9
ispXPLD 5768	0.004719	0.0924	4.4	2.9
ispXPLD 51024	0.004719	0.0924	4.4	2.9

- K0 = Current per MFB input ($\mu\text{A}/\text{MHz}$)
- K1 = Current per Product Term ($\mu\text{A}/\text{MHz}$)
- K2 = Current per GRP from MFB ($\mu\text{A}/\text{MHz}$)
- K3 = Current per GRP from I/O ($\mu\text{A}/\text{MHz}$)
- K4 = Global clock tree current ($\mu\text{A}/\text{MHz}$)
- K5 = PLL digital (mA/MHz)
- K6 = PLL analog (mA/MHz)
- K7 = PLL analog baseline (mA)
- DC = Baseline current at 0MHz (mA)
- K8 = CAM frequency component (mA/MHz)
- K9 = CAM DC component (mA)
- K10 = Current per row decoder ($\mu\text{A}/\text{MHz}$)
- K11 = Current per column driver ($\mu\text{A}/\text{MHz}$)

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
2	20P	C14	-	-	C15	P11
2	20N	C16/VREF2	-	-	C17	T14
2	21P	C18	C8	D8	C19	R12
2	21N	C20	C9	D9	-	R13
2	22P	C21	C10	D10	-	N11
2	22N	C22	C11	D11	C23	T15
2	23P	C24	C12	D12	C25	R14
2	23N	C26	C13	D13	C27	N12
2	24P	C28	C14	D14	C29	P12
2	24N	C30	C15	D15	C31	R15
-	-	VCCO2	-	-	-	VCCO2
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	25P	D0	-	-	D1	N15
2	25N	D2	-	-	D3	N14
2	26P	D4	C16	D16	-	N16
2	26N	D5	C17	D17	-	M16
2	27P	D6	C18	D18	D7	M14
2	27N	D8	C19	D19	D9	M15
-	-	VCC	-	-	-	VCC
2	28P	D10	C20	D20	D11	L13
2	28N	D12	C21	D21	D13	L12
2	29P	D14	C22	D22	D15	L15
2	29N	D16	C23	D23	D17	L16
-	-	GND	-	-	-	GND
2	30P	D18	C24	D24	D19	L14
-	-	VCCO2	-	-	-	VCCO2
2	30N	D20	C25	D25	-	K15
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	31P	D21	C26	D26	-	K14
2	31N	D22	C27	D27	D23	K12
2	32P	D24	C28	D28	D25	K13
2	32N	D26	C29	D29	D27	J13
2	33P	D28	C30	D30	D29	J14
2	33N	D30	C31	D31	D31	J12
-	-	TOE	-	-	-	J15
-	-	RESET	-	-	-	J11
-	-	GOE0	-	-	-	H11
-	-	GOE1	-	-	-	H13
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3N	GCLK2	-	-	-	H15
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table
-	GCLK3P	GCLK3	-	-	-	H16

ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	34N	E30	-	-	E31	H14
3	34P	E28	-	-	E29	G16
3	35N	E26	-	-	E27	G15
3	35P	E24/PLL_FBK1	-	-	E25	F15
3	36N	E22/PLL_RST1	E27	F27	E23	H12
3	36P	E21	E26	F26	-	G14
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	37N	E20	E25	F25	-	F16
-	-	VCCO3	-	-	-	VCCO3
3	37P	E18	E24	F24	E19	E16
-	-	GND	-	-	-	GND
3	38N	E16	E23	F23	E17	G13
3	38P	E14	E22	F22	E15	G12
3	39N	E12	E21	F21	E13	F14
3	39P	E10/CLK_OUT1	E20	F20	E11	E15
-	-	VCC	-	-	-	VCC
3	40N	E8	E19	F19	E9	D12
3	40P	E6	E18	F18	E7	B14
3	41N	E5	E17	F17	-	C13
3	41P	E4	E16	F16	-	A14
3	42N	E2	E31	F31	E3	A13
3	42P	E0	E30	F30	E1	B13
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
-	-	VCCO3	-	-	-	VCCO3
3	43N	F30	E15	F15	F31	B11
3	43P	F28	E14	F14	F29	C11
3	44N	F26	E13	F13	F27	B10
3	44P	F24	E12	F12	F25	A10
3	45N	F22	E11	F11	F23	C10
3	45P	F21	E10	F10	-	D10
3	46N	F20	E9	F9	-	C9
3	46P	F18	E8	F8	F19	E9
3	47N	F16/VREF3	E29	F29	F17	D9
3	47P	F14	E28	F28	F15	F9
3	48N	F12	E7	F7	F13	A9
3	48P	F10	E6	F6	F11	F8
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)
3	49N	F8	E5	F5	F9	E8
-	-	VCCO3	-	-	-	VCCO3
3	49P	F6	E4	F4	F7	A8
3	50N	F5	E3	F3	-	B9
3	50P	F4	E2	F2	-	D8
-	-	VCC	-	-	-	VCC

ispXPLD 5512MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	208 PQFP Pin Number	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2				
0	109N	O30	O11	P18	O31	208	C4	B4
0	109P	O28	O10	P16	O29	1	E4	A4
0	110N	O26	M17	O17	O27	2	B1	B3
0	110P	O24	M16	O16	O25	3	C1	A3
0	111N	O22	M15	O15	O23	4	D3	F5
—	—	V _{CC00}	—	—	—	5	V _{CC00}	V _{CC00}
0	111P	O20	M14	O14	O21	6	C2	G6
—	—	GND (Bank 0)	—	—	—	7	GND (Bank 0)	GND (Bank 0)
0	112N	O18	M13	O13	O19	8	E3	H6
0	112P	O16	M12	O12	O17	9	D2	G5
0	113N	O14	O9	P14	O15	—	—	D3
0	113P	O12	O8	P12	O13	—	—	D2
0	114N	O10	O7	P10	O11	—	—	E4
0	114P	O8	O6	P8	O9	—	—	E3
0	115N	O6	O5	P6	O7	—	—	F4
0	115P	O4	O4	P4	O5	—	—	G4
0	116N	O2	O3	P2	O3	—	—	C2
—	—	V _{CC00}	—	—	—	—	V _{CC00}	V _{CC00}
0	116P	O0	O2	P0	O1	—	—	C1
—	—	GND (Bank 0)	—	—	—	—	GND (Bank 0)	GND (Bank 0)
0	117N	P30	O1	—	P31	—	D1	F3
0	117P	P28	O0	—	P29	—	E1	G3
0	118N	P26	O31	—	P27	—	F4	H4
—	—	V _{CC}	—	—	—	10	V _{CC}	V _{CC}
0	118P	P24	O30	—	P25	—	F5	J4
0	119N	P22	M11	O11	P23	11	E2	H5
0	119P	P20/CLK_OUT0	M10	O10	P21	12	F2	J5
0	120N	P18	M9	O9	P19	13	F1	E2
0	120P	P16	M8	O8	P17	14	G1	F2
—	—	GND	—	—	—	15	GND	GND
0	121N	P14	M7	O7	P15	16	F3	D1
—	—	V _{CC00}	—	—	—	17	V _{CC00}	V _{CC00}
0	121P	P12	M6	O6	P13	18	G5	E1
—	—	GND (Bank 0)	—	—	—	19	GND (Bank 0)	GND (Bank 0)
0	122N	P10	M5	O5	P11	20	H5	J3
0	122P	P8/PLL_RST0	M4	O4	P9	21	G4	H2
0	123N	P6	—	—	P7	22	G3	G2
0	123P	P4/PLL_FBK0	—	—	P5	23	H3	G1
0	124N	P2	—	—	P3	24	G2	H1
0	124P	P0	—	—	P1	25	H1	J1
—	GCLK0P	GCLK0	—	—	—	26	H2	N7
—	—	V _{CCJ}	—	—	—	See Power Supply and NC Connections Table		

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
1	-	C28	D14	-	C29	P5	U8
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	15P	C26	D16	-	C27	T4	V6
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	15N	C24	D18	-	C25	T5	V7
-	-	GND	-	-	-	GND	GND
1	16P	C22	D20	-	C23	R4	Y5
-	-	VCC	-	-	-	VCC	VCC
1	16N	C20	D22	-	C21	N6	AA5
1	17P	C18	-	-	C19	R5	Y6
1	17N	C16	-	-	C17	P6	Y7
1	18P	C14	-	-	C15	-	AA6
1	18N	C12	-	-	C13	-	AA7
1	19P	C10	-	-	C11	-	W7
1	19N	C8	-	-	C9	M7	V8
1	20P	C6	-	-	C7	T6	W8
1	20N	C4	-	-	C5	R6	U9
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
-	-	CFG0	-	-	-	L8	U10
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	21P	C0	C16	A16	C1	T7	AB7
1	21N	D30	C17	A17	D31	R7	AA8
1	22P	D28	C18	A18	D29	N7	AB8
1	22N	D26	C19	A19	D27	P7	AB9
1	23P	D24	C20	A20	D25	T8	W9
1	23N	D22	C21	A21	D23	R8	Y9
1	24P	D20	C22	A22	D21	M8	AB10
1	24N	D18	C23	A23	D19	P8	AA10
1	-	D16/VREF1	-	-	D17	L9	W10
1	25P	D14	C24	A24	D15	N8	Y10
1	25N	D12	C25	A25	D13	M9	Y11
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)	GND (Bank 1)
1	26P	D10	C26	A26	D11	N10	V9
-	-	VCCO1	-	-	-	VCCO1	VCCO1
1	26N	D8	C27	A27	D9	T9	V10
1	27P	D6	C28	A28	D7	T10	AA11
-	-	GND	-	-	-	GND	GND
1	27N	D4	C29	A29	D5	R9	AB11
-	-	VCC	-	-	-	VCC	VCC
1	28P	D2	C30	A30	D3	P9	U11
1	28N	D0	C31	A31	D1	N9	V11
2	29P	E0	F0	H0	E1	T11	AB12
-	-	VCC	-	-	-	VCC	VCC

ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCC	-	-	-	VCC	VCC
0	109P	Q28	Q30	S30	Q29	A7	C11
-	-	GND	-	-	-	GND	GND
0	110N	Q26	Q29	S29	Q27	D7	B11
0	110P	Q24	Q28	S28	Q25	C7	A11
0	111N	Q22	Q27	S27	Q23	B6	F11
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	111P	Q20	Q26	S26	Q21	E7	F10
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	112N	Q18	Q25	S25	Q19	E6	E10
0	112P	Q16	Q24	S24	Q17	A6	C10
0	113N	Q14/VREF0	Q3	S3	Q15	A5	D10
0	113P	Q12	Q2	S2	Q13	A4	B10
0	114N	Q10	Q23	S23	Q11	B5	A10
0	114P	Q8	Q22	S22	Q9	A3	A9
0	115N	Q6	Q21	S21	Q7	B4	C9
0	115P	Q4	Q20	S20	Q5	B3	D9
0	116N	Q2	Q19	S19	Q3	C5	F9
0	116P	Q0	Q18	S18	Q1	C6	E9
0	117N	R30	Q1	S1	R31	D5	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	117P	R28	Q0	S0	R29	D6	B8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	118N	R26	S29	-	R27	—	A7
0	118P	R24	S28	-	R25	—	B7
0	119N	R22	S27	-	R23	—	A5
0	119P	R20	S26	-	R21	—	B5
0	120N	R18	S25	-	R19	—	B6
0	120P	R16	S24	-	R17	—	C7
0	121N	R14	S23	-	R15	—	E8
0	121P	R12	S22	-	R13	—	E7
0	122N	R10	S21	-	R11	—	E6
-	-	VCC	-	-	-	VCC	VCC
0	122P	R8	S20	-	R9	—	D6
-	-	GND	-	-	-	GND	GND
0	123N	R6	S19	-	R7	—	D8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	123P	R4	S18	-	R5	—	F8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	124N	R2	S17	-	R3	—	F7
0	124P	R0	S16	-	R1	—	D7
0	125N	S30	S15	-	S31	A2	C6
0	125P	S28	S14	-	S29	B2	C5

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	175N	AC22	AC27	AE27	AC23	K6	J5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	175P	AC20	AC26	AE26	AC21	K3	J4
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	176N	AC18	AC25	AE25	AC19	K5	K7
0	176P	AC16	AC24	AE24	AC17	K2	L7
0	177N	AC14	AC23	AE23	AC15	L5	J3
0	177P	AC12	AC22	AE22	AC13	K1	J2
0	178N	AC10	AC21	AE21	AC11	L6	K6
0	178P	AC8	AC20	AE20	AC9	L1	L6
0	179N	AC6	AC19	AE19	AC7	M5	K5
0	179P	AC4	AC18	AE18	AC5	L2	K4
0	180N	AC2	AC17	AE17	AC3	N5	K3
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	180P	AC0	AC16	AE16	AC1	L3	K2
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	181N	AE30	AC15	AE15	AE31	M6	K1
0	181P	AE28	AC14	AE14	AE29	M2	L2
0	182N	AE26	AC13	AE13	AE27	P5	L5
-	-	VCC	-	-	-	VCC	VCC
0	182P	AE24	AC12	AE12	AE25	P6	L4
0	183N	AE22	AC11	AE11	AE23	M3	L3
0	183P	AE20	AC10	AE10	AE21	N6	M3
0	184N	AE18	AC9	AE9	AE19	N2	M7
0	184P	AE16	AC8	AE8	AE17	P1	N7
-	-	GND	-	-	-	GND	GND
0	185N	AE14	AC7	AE7	AE15	N3	M5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	185P	AE12	AC6	AE6	AE13	M8	M4
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	186N	AE10	AC5	AE5	AE11	N8	M6
0	186P	AE8	AC4	AE4	AE9	P2	N6
0	187N	AE6	AC3	AE3	AE7	P8	M2
0	187P	AE4	AC2	AE2	AE5	N4	M1
0	188N	AE2	AC1	AE1	AE3	H1	N1
0	188P	AE0	AC0	AE0	AE1	J1	N2
-	GCLK0P	GCLK0	-	-	-	N7	N5
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table	
-	GCLK0N	GCLK1	-	-	-	P7	N3
-	-	GND	-	-	-	GND	GND
-	-	TDI	-	-	-	R1	P4
-	-	TMS	-	-	-	R2	P5

ispXPLD 51024MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	110N	U4	X25	V25	U5	H21	J21
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	110P	U6	X24	V24	U7	G21	H21
-	-	GND	-	-	-	GND	GND
3	111N	U8	X23	V23	U9	D22	G25
3	111P	U10	X22	V22	U11	D21	G24
3	112N	U12	X21	V21	U13	J20	G23
3	112P	U14/CLK_OUT1	X20	V20	U15	J19	G22
3	113N	U16	V31	-	U17	E20	J20
-	-	VCC	-	-	-	VCC	VCC
3	113P	U18	V30	U30	U19	F20	H20
3	114N	U20	V29	U28	U21	H17	G26
3	114P	U22	V28	U26	U23	H18	F25
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	115N	U24	V27	-	U25	J18	F24
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	115P	U26	V26	-	U27	H19	F23
3	116N	U28	V25	-	U29	G20	G21
3	116P	U30	V24	-	U31	G19	F22
-	-	GND	-	-	-	GND	GND
3	117N	V0	V23	-	V1	C22	F26
-	-	VCC	-	-	-	VCC	VCC
3	117P	V2	V22	-	V3	C21	E26
3	118N	V4	V21	-	V5	D20	E25
3	118P	V6	V20	-	V7	C19	E24
3	119N	V8	V19	-	V9	F19	E23
3	119P	V10	V18	-	V11	E19	E22
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	120N	V12	V17	-	V13	G18	D26
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	120P	V14	V16	-	V15	F18	D25
3	121N	V16	V15	-	V17	B20	D24
3	121P	V18	V14	-	V19	B19	D23
3	122N	V20	V13	-	V21	A20	C26
3	122P	V22	V12	-	V23	A19	C25
3	123N	V24	X19	V19	V25	D18	G19
3	123P	V26	X18	V18	V27	C18	F19
3	124N	V28	X17	V17	V29	G17	G18
3	124P	V30	X16	V16	V31	F16	F18
3	125N	W0	X31	V31	W1	E17	F20
3	125P	W2	X30	V30	W3	D17	E20
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)